

ESPROS Photonics Corporation



Next generation pulsed time-of-flight sensors for autonomous driving

Beat De Coi

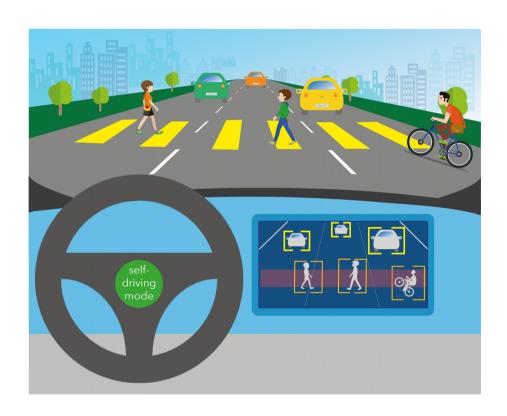


Topics

- ADAS requirements
- Sensor technology overview
- ESPROS CCD/CMOS technology OHC15LTM
- Technology comparison of receiver elements
- Performance data of EPSORS OHC15L™ Imaging LiDAR
- A few words about the company



Our driving future: The aim of ESPROS



«Siri, drive me home, please!»

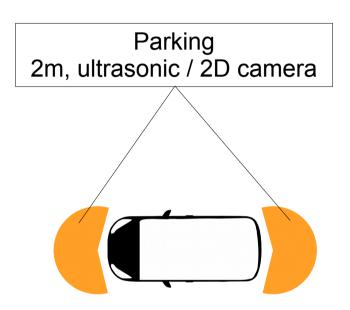


Requirements and solutions today



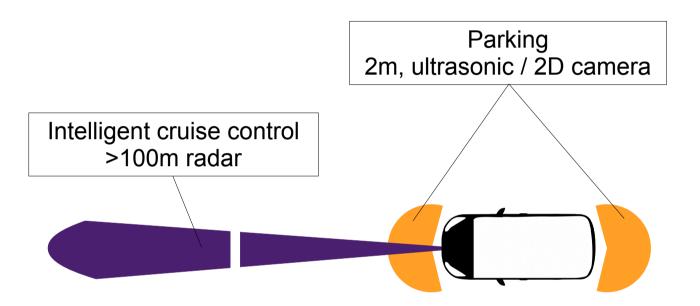


Requirements and solutions today



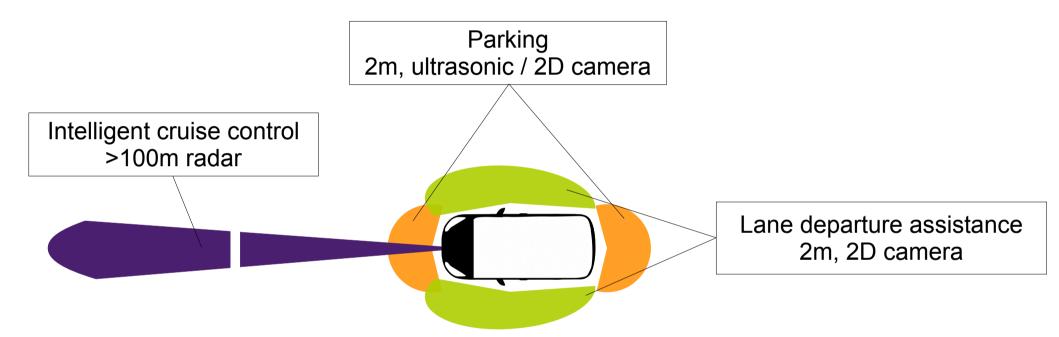


Requirements and solutions today



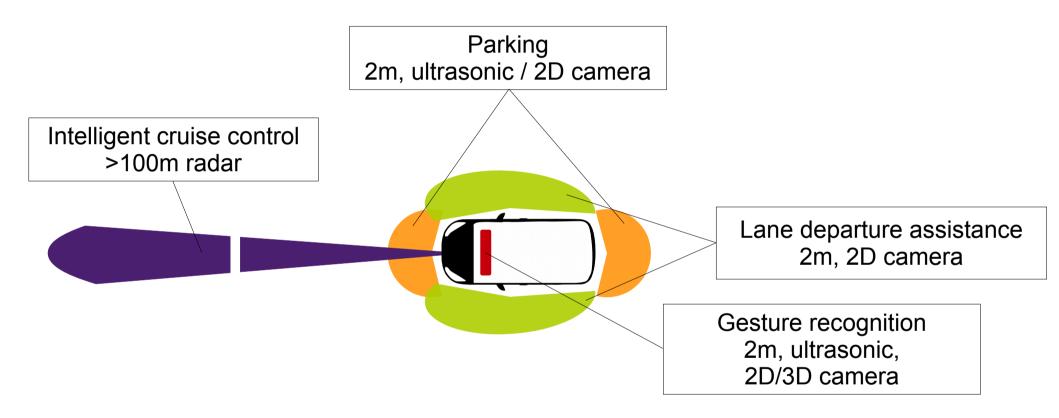


Requirements today



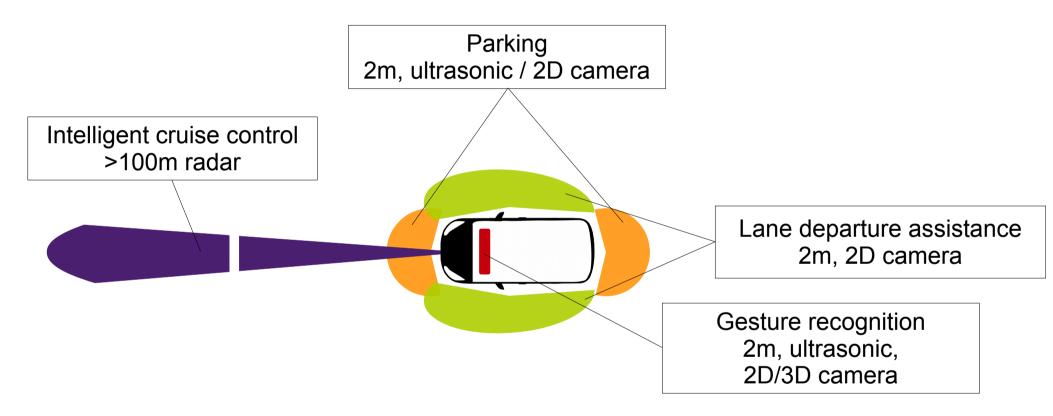


Requirements today





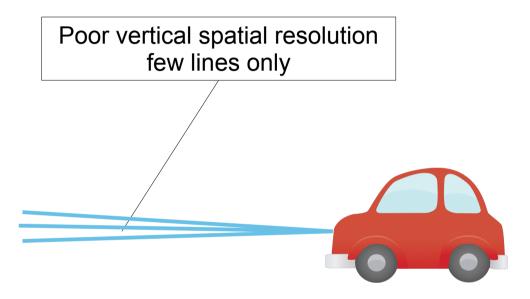
Requirements today



- Quite good sensors and technologies available
- Already well deployed and mature



Current LiDAR solutions



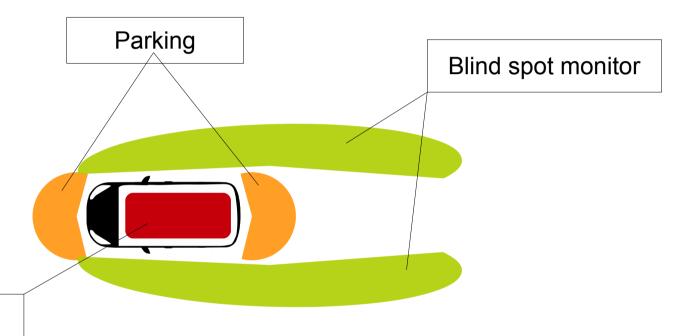


Future requirements:





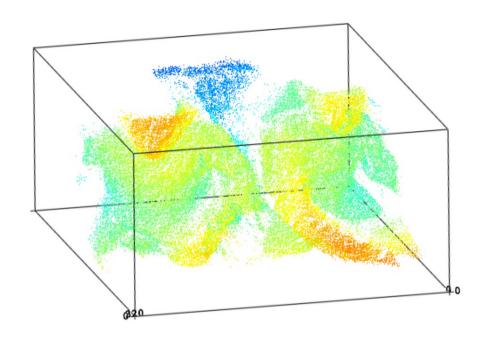
Future requirements: close range with cwTOF



- Gesture recognition
- seat position
- Driver awareness
- left behind objects



Already existing imaging cwTOF OHC15L™





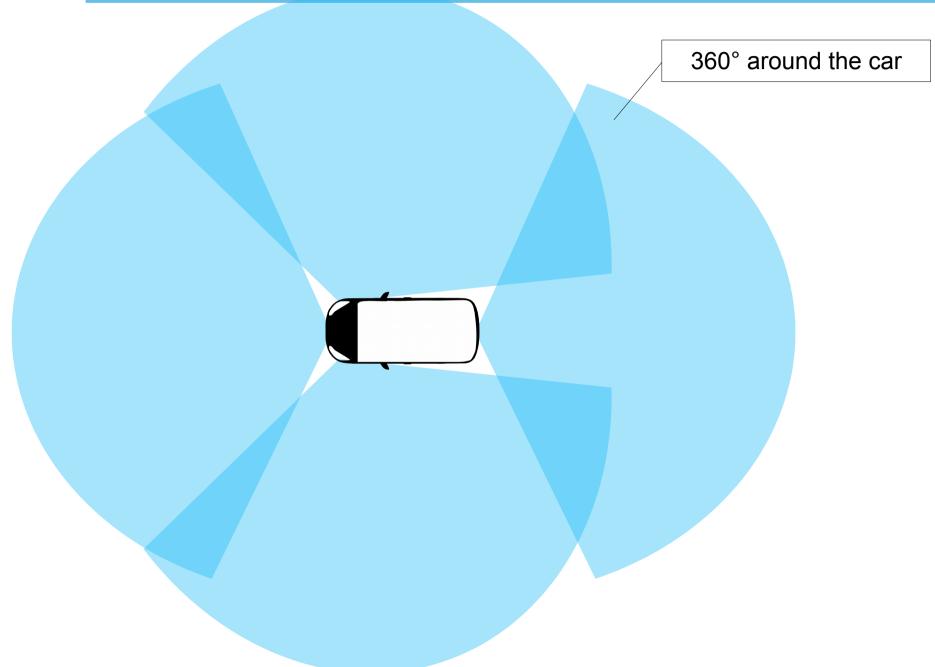
- Lens
 - Lens F# 1
- hFOV
 - vFOV
- LED power
- F# 1.4
- 94°
- 70°
- 1W (cw)

- Frame rate
- Wavelength
- Range
- Sunlight

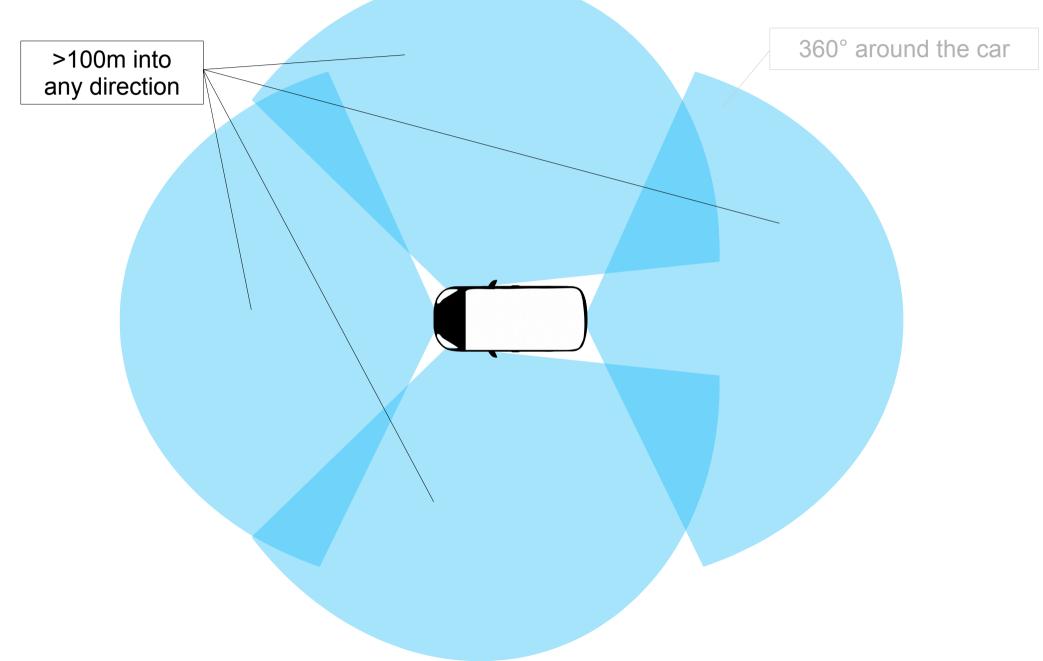
- 50fps
- 850nm
- 6m
- >100kLux



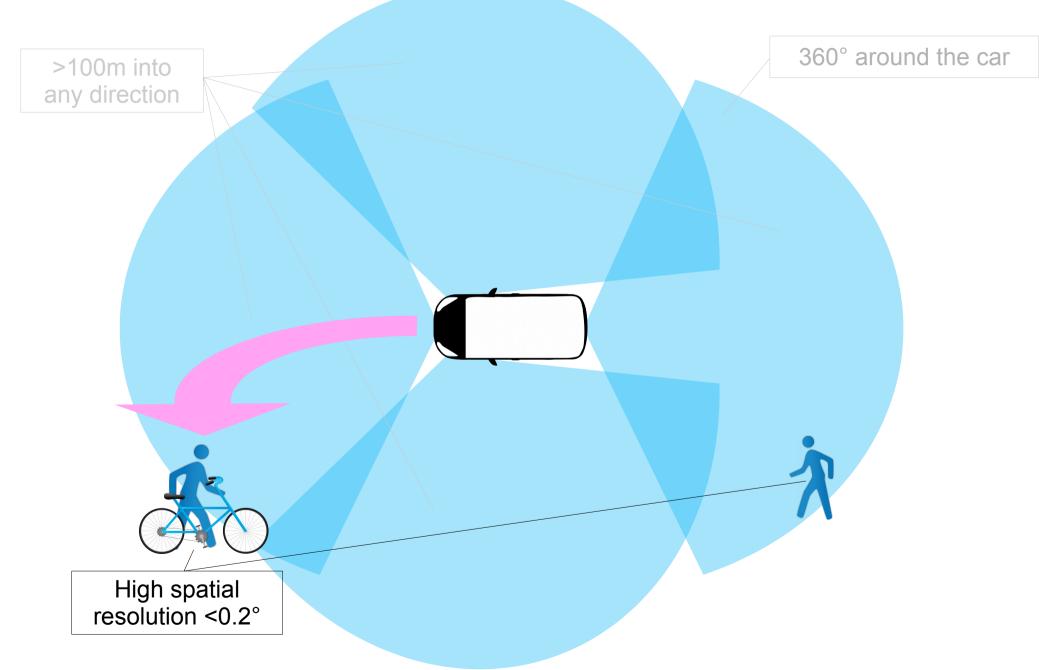






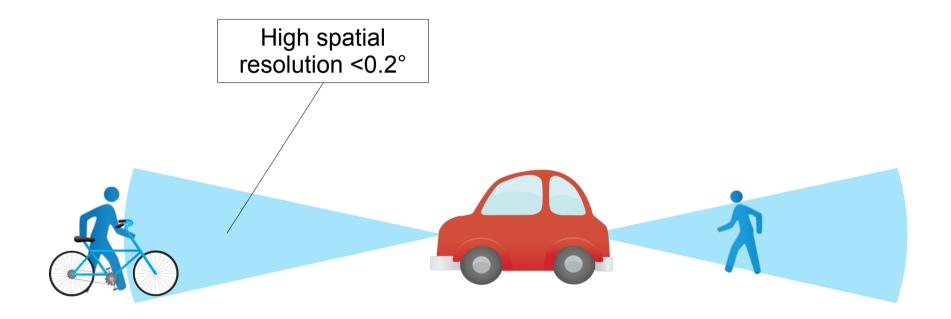






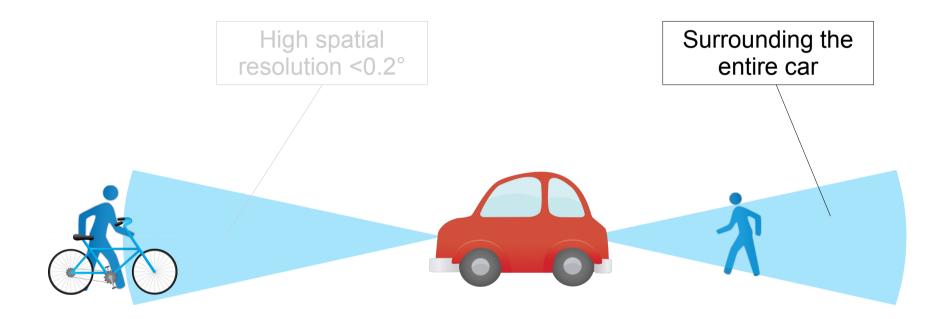


Future requirements: Large vertical FOV, high spatial resolution





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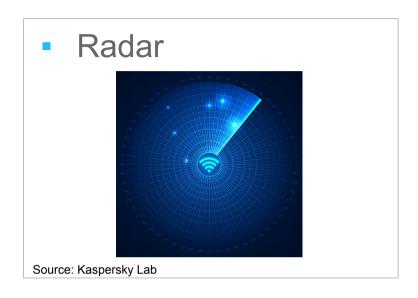


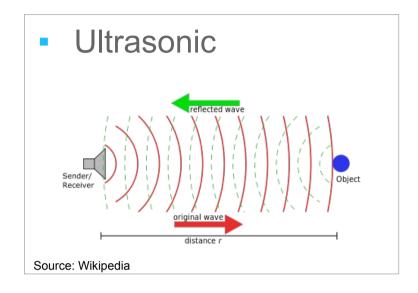
Sensor requirements summary

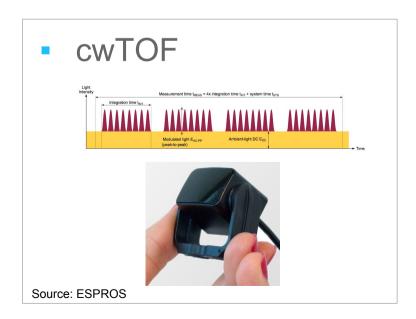
Long range	>100m
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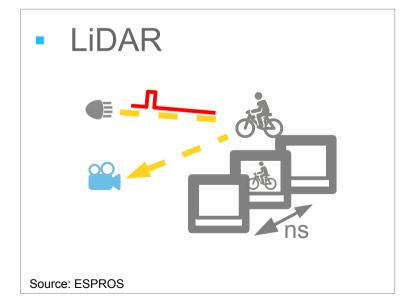


Sensor technology overview









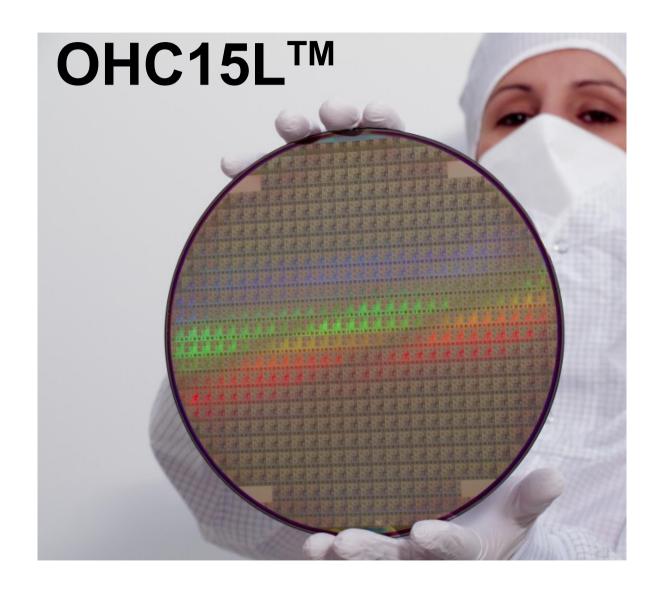


Technology comparison

Parameter	Requirement	Radar	Ultrasonic	cwTOF	pTOF (Imaging LiDAR)
Long range	≥100m				
Short range	0 2m				
Spatial resolution	≥0.2°				
FOV horizontal	360°				
FOV vertical	≥25°				
Distance resolution	cm				
Weather condition	all weather				
Daytime	day & night				
Response time	>25 fps				
Safety	eye safe, ASIL				
Multiple sensors	no interference				
Cost	low				

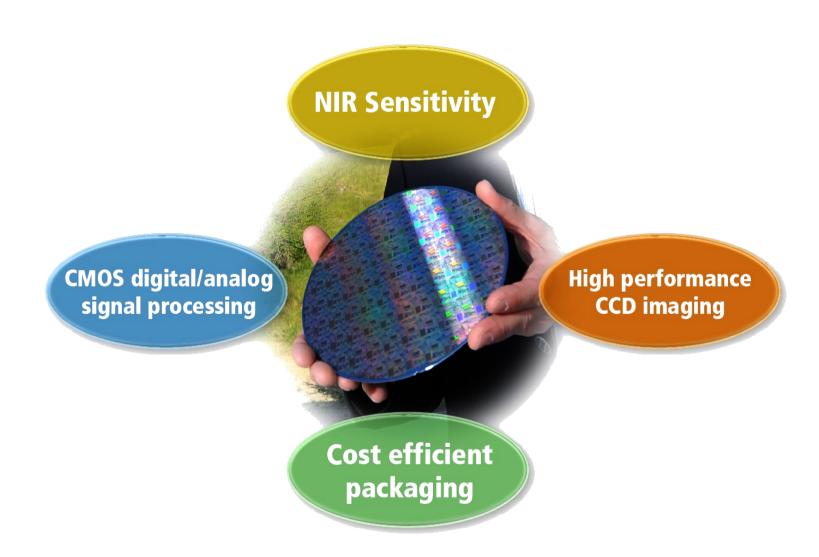


ESPROS imaging LiDAR technology



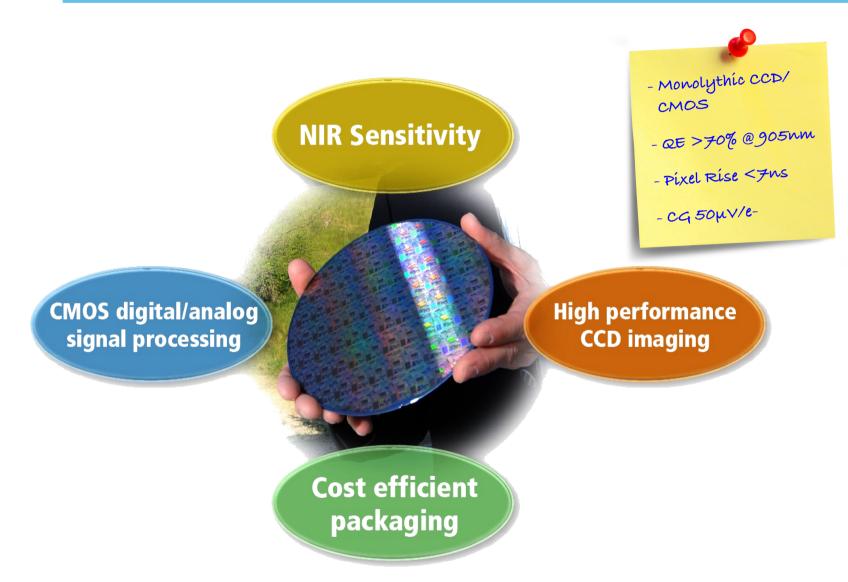


Key ingredients needed for a good LiDAR imager





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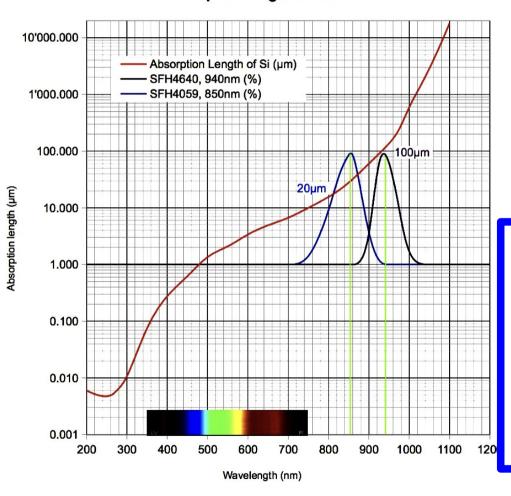




ESPROS OHC15L™ technical concept

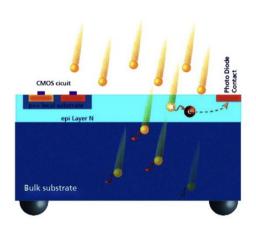


Absorption length in Silicon



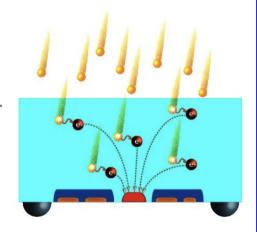
CONVENTIONAL CMOS

- a) thin active layer
- b) 20% fill factor only



ESPROS OHC15L™

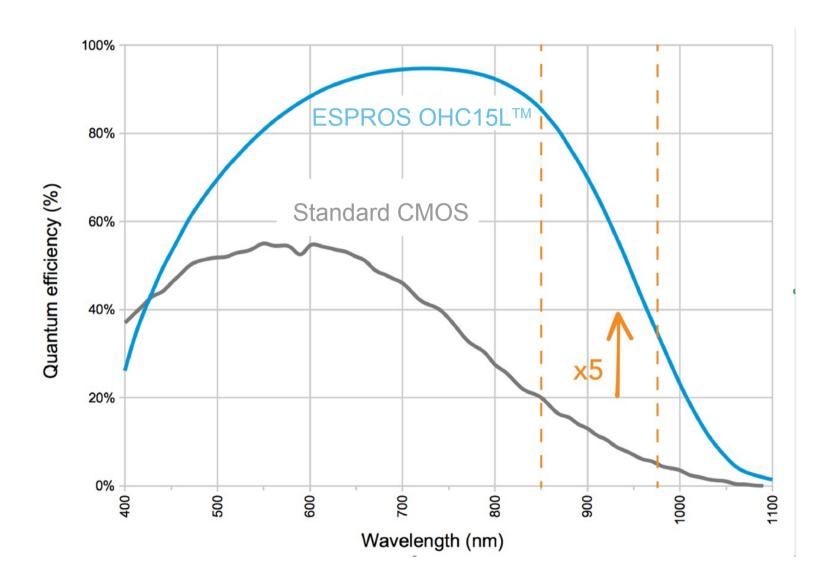
- a) 50 micron absorber
- b) 100% fill factor





Quantum efficiency improvement

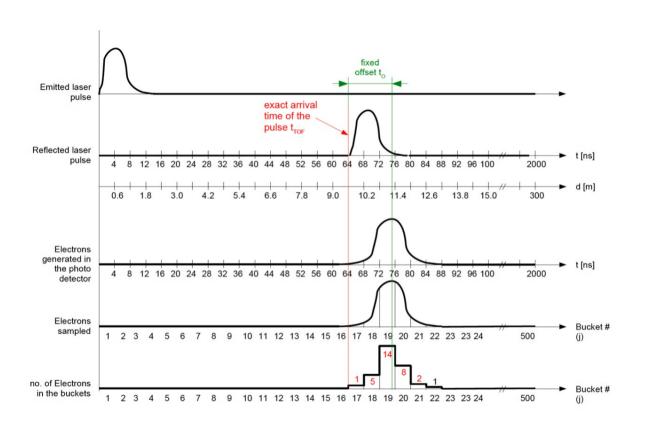












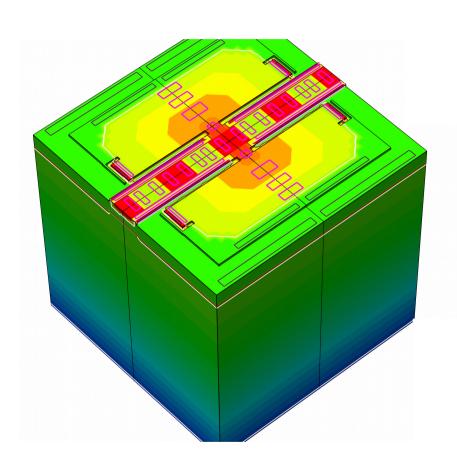
Working principle:

- Sampling of arriving light pulses into fast CCD
- A/D conversion of the sampled signal
- Calculation of the exact pulse arrival time point
- Multiple echoes from one laser pulse are detectable



ESPROS pTOF pixel (example)





Pixel & imager parameters:

• QE >70% @ 905nm

Speed 6.5ns (FWHM)

Sensitivity 20e-

CCD sampling 250MHz

CCD 450 stages (270m)

Pixel pitch 45µm

• Field 262 x 150 pixel

No. of pixels 38,864

Frame rate >100fps (full 3D TOF)

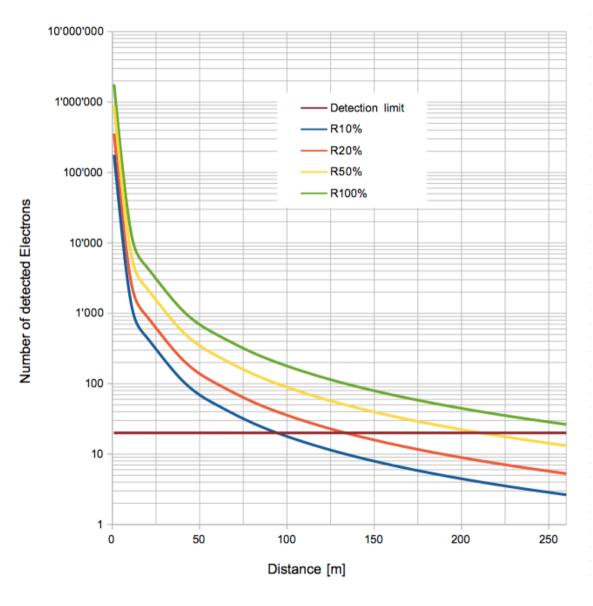


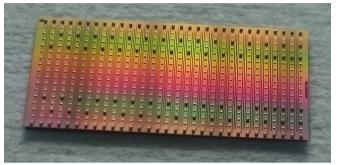
Comparison of receiver device technology

Parameter	APD	SPAD	ESPROS OHC15L™
Rise time	2ns	300ps	6ns
Bias voltage	200V	30V	10V
Max. no. of electrons	unlimited	up to 100	10 ⁶
Photo detection efficiency	80%	8%	70%
Min cell distance (pixel pitch)	30µm	25μm	7.5µm
Sensitivity (practical)	15 photons	6 photons	20 photons
Night vision	impossible	poor	good
Typ. Resolution	16 (64)	1,000	40,000
Cost per channel	very high	medium	very low



ESPROS pTOF operating range performance





LiDAR Imager

System parameters:

Lens	F	#	0	8.
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hFOV	50°
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At the end: A few words to ESPROS





At the end: A few words about ESPROS





Key data

- Established in 2006
- Privately held corporation
- 70 million CHF initial investment
- Photonics chip design and manufacturing
- 60'000m² space built into solid rock for further expansion
- Technology protected with 15 patents or patent applications

Locations

- HQ Sargans, Switzerland
- Regional offices: USA and China
- 600m² class 1-10 cleanroom for backside processing
- 360m² class 1000 cleanroom for testing, backend and assembly

Supply Chain

- Frontside processing of OHC15L[™] by TSMC
- Established 2nd sources
- Product qualification according
 JEDEC and AEC-Q100 standards

Products

- 1, 8x8, 160x60, 320x240 pixel cwTOF image
- Customer specific gated imagers
- Customer specific pTOF imagers



Thank you!



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